Micropower 150 mA LDO Linear Regulators with DELAY, Adjustable RESET, and Monitor FLAG

The NCV8502 is a family of precision micropower voltage regulators. Their output current capability is 150 mA. The family has output voltage options for adjustable, 2.5 V, 3.3 V, 5.0 V, 8.0 V, and 10 V.

The output voltage is accurate within $\pm 2.0\%$ with a maximum dropout voltage of 0.6 V at 150 mA. Low quiescent current is a feature drawing only 90 μ A with a 100 μ A load. This part is ideal for any and all battery operated microprocessor equipment.

Microprocessor control logic includes an active $\overline{\text{RESET}}$ (with DELAY), and a FLAG monitor which can be used to provide an early warning signal to the microprocessor of a potential impending $\overline{\text{RESET}}$ signal. The use of the FLAG monitor allows the microprocessor to finish any signal processing before the $\overline{\text{RESET}}$ shuts the microprocessor down.

The active $\overline{\text{RESET}}$ circuit operates correctly at an output voltage as low as 1.0 V. The $\overline{\text{RESET}}$ function is activated during the power up sequence or during normal operation if the output voltage drops outside the regulation limits.

The reset threshold voltage can be decreased by the connection of external resistor divider to R_{ADJ} lead.

The regulator is protected against reverse battery, short circuit, and thermal overload conditions. The device can withstand load dump transients making it suitable for use in automotive environments. The device has also been optimized for EMC conditions.

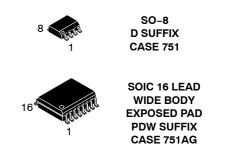
Features

- Output Voltage Options: Adjustable, 2.5 V, 3.3 V, 5.0 V, 8.0 V, 10 V
- ±2.0% Output
- Low 90 µA Quiescent Current
- Fixed or Adjustable Output Voltage
- Active **RESET**
- Adjustable Reset
- 150 mA Output Current Capability
- Fault Protection
 - +60 V Peak Transient Voltage
 - ♦ -15 V Reverse Voltage
 - Short Circuit
 - Thermal Overload
- Early Warning through FLAG/MON Leads
- NCV Prefix for Automotive and Other Applications Requiring Site and Change Control
- AEC Qualified
- PPAP Capable
- These are Pb–Free Devices

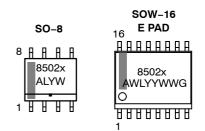


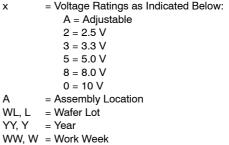
ON Semiconductor®

http://onsemi.com



MARKING DIAGRAMS



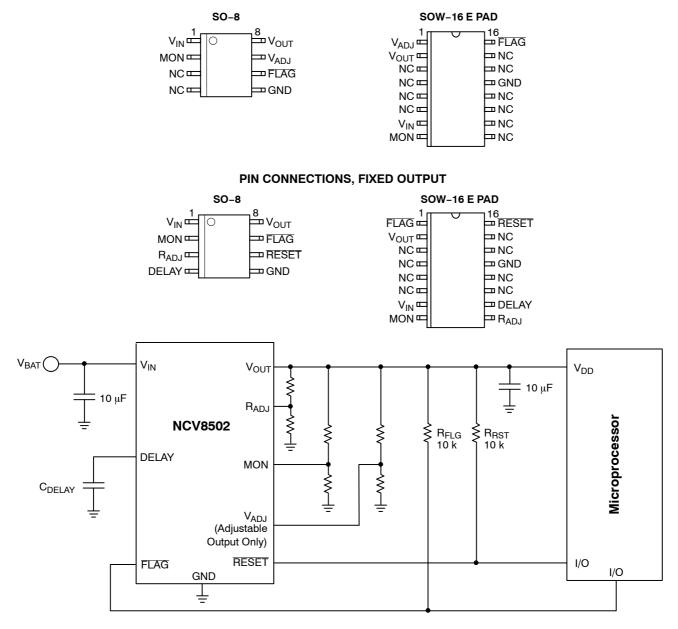


G or = Pb-Free Device

ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 12 of this data sheet.

PIN CONNECTIONS, ADJUSTABLE OUTPUT





MAXIMUM RATINGS*

| Rating | Value | Unit |
|--|------------|------|
| V _{IN} (dc) | -15 to 48 | V |
| Peak Transient Voltage (46 V Load Dump @ V _{IN} = 14 V) | 60 | V |
| Operating Voltage | 45 | V |
| V _{OUT} (dc) | –0.3 to 16 | V |
| Voltage Range (RESET, FLAG) | –0.3 to 10 | V |

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

*During the voltage range which exceeds the maximum tested voltage of V_{IN}, operation is assured, but not specified. Wider limits may apply. Thermal dissipation must be observed closely.

MAXIMUM RATINGS* (continued)

| Rating | Symbol | Value | Unit |
|--|--|----------------|----------------------|
| Input Voltage Range (MON, V _{ADJ} , R _{ADJ}) | | –0.3 to 10 | V |
| ESD Susceptibility (Human Body Model) | | 2.0 | kV |
| Junction Temperature | TJ | -40 to +150 | °C |
| Storage Temperature | Τ _S | –55 to 150 | °C |
| Package Thermal Resistance, SO-8: Junctior Junctior | R _{θJC} R _{θJA} | 45 165 | °C/W °C/W |
| Package Thermal Resistance, SOW-16 E PAD: | R _{θJC} R _{θJA} R _{θJP} | 15 56 35 | °C/W °C/W °C/W |
| Lead Temperature Soldering: SMD style only, Reflo Pb-Free Part 60 - 150 sec above 217°C, 40 sec | SLD | 265 peak | °C |

1. Measured to pin 16.

Per IPC / JEDEC J-STD-020C.
 *During the voltage range which exceeds the maximum tested voltage of V_{IN}, operation is assured, but not specified. Wider limits may apply. Thermal dissipation must be observed closely.

 $\textbf{ELECTRICAL CHARACTERISTICS} \text{ (I}_{OUT} = 1.0 \text{ mA}, -40^{\circ}\text{C} \leq T_J \leq 150^{\circ}\text{C}; \text{ V}_{IN} = \text{dependent on voltage option (Note 3); unless}$ otherwise specified.)

| Characteristic | Test Conditions | Min | Тур | Max | Unit |
|---|---|-------|------------|------------|----------|
| Output Stage | | | | | |
| Output Voltage for 2.5 V Option | 6.5 V < V _{IN} < 16 V, 100 μ A \leq I _{OUT} \leq 150 mA | 2.450 | 2.5 | 2.550 | V |
| | 5.5 V < V_{IN} < 26 V , 100 μ A \leq I _{OUT} \leq 150 mA | 2.425 | 2.5 | 2.575 | V |
| Output Voltage for 3.3 V Option | 7.3 V < V _{IN} < 16 V, 100 $\mu A \leq I_{OUT} \leq$ 150 mA | 3.234 | 3.3 | 3.366 | V |
| | 5.5 V < V _{IN} < 26 V , 100 μ A \leq I _{OUT} \leq 150 mA | 3.201 | 3.3 | 3.399 | V |
| Output Voltage for 5.0 V Option | 9.0 V < V _{IN} < 16 V, 100 μ A \leq I _{OUT} \leq 150 mA | 4.90 | 5.0 | 5.10 | V |
| | 6.0 V < V _{IN} < 26 V , 100 μ A \leq I _{OUT} \leq 150 mA | 4.85 | 5.0 | 5.15 | V |
| Output Voltage for 8.0 V Option | 9.0 V < V _{IN} < 26 V , 100 μ A \leq I _{OUT} \leq 150 mA | 7.76 | 8.0 | 8.24 | V |
| Output Voltage for 10 V Option | 11 V < V _{IN} < 26 V, 100 μ A \leq I _{OUT} \leq 150 mA | 9.7 | 10 | 10.3 | V |
| | | | | | V |
| Output Voltage for Adjustable | V _{OUT} = V _{ADJ} (Unity Gain) | | | | |
| Option | $6.5 \text{ V} < \text{V}_{\text{IN}} < 16 \text{ V}, 100 \ \mu\text{A} < \text{I}_{\text{OUT}} < 150 \text{ mA}$ | 1.254 | 1.280 | 1.306 | V |
| | 5.5 V < V _{IN} < 26 V, 100 μA < I _{OUT} < 150 mA | 1.242 | 1.280 | 1.318 | V |
| Dropout Voltage (V _{IN} – V _{OUT}) | $I_{OUT} = 150 \text{ mA}$ | - | 400 | 600 | mV |
| (5.0 V, 8.0 V, 10 V and Adj. > 5.0 V Options Only) | I _{OUT} = 1.0 mA | - | 100 | 150 | mV |
| Load Regulation | V_{IN} = 14 V, 5.0 mA $\leq I_{OUT} \leq$ 150 mA | -30 | 5.0 | 30 | mV |
| Line Regulation | [V _{OUT} (Typ) + 1.0] < V _{IN} < 26 V, I _{OUT} = 1.0 mA | - | 15 | 60 | mV |
| Quiescent Current, Low Load | I_{OUT} = 100 μ A, V_{IN} = 12 V, MON = V_{OUT} | | | | |
| 2.5 V Option | | - | 90 | 125 | μA |
| 3.3 V Option 5.0 V Option | | - | 90 | 125 | μA |
| 8.0 V Option | | - | 90 | 125 | μA |
| 10 V Option | | - | 100 100 | 150 150 | μA |
| Adjustable Option | | _ | 50 | 75 | μA μA |
| Ouissesset Oursest Madium Land | | | | | |
| Quiescent Current, Medium Load All Options | I_{OUT} = 75 mA, V_{IN} = 14 V, MON = V_{OUT} | _ | 4.0 | 6.0 | mA |
| Quiescent Current, High Load All Options | I_{OUT} = 150 mA, V_{IN} = 14 V, MON = V_{OUT} | - | 12 | 19 | mA |
| Current Limit | - | 151 | 300 | - | mA |

3. Voltage range specified in Output Stage of the Electrical Characteristics in boldface type.

 $\textbf{ELECTRICAL CHARACTERISTICS (continued)} (I_{OUT} = 1.0 \text{ mA}; -40^{\circ}\text{C} \le T_J \le 150^{\circ}\text{C}; V_{IN} = \text{dependent on voltage option (Note 4)}; \\ \textbf{S}_{IN} = \textbf{S}_{IN}$ unless otherwise specified.)

| Characteristic | Test Conditions | Min | Тур | Max | Unit |
|---|---|--------------|----------------|--|--------|
| Output Stage | | | | | |
| Short Circuit Output Current | V _{OUT} = 0 V | 40 | 190 | - | mA |
| Thermal Shutdown | (Guaranteed by Design) | 150 | 180 | - | °C |
| Reset Function (RESET) | | · | • | | |
| RESET Threshold for 2.5 V Option HIGH (V _{RH}) LOW (V _{RL}) | $5.5~V \leq V_{IN} \leq 26~V$ (Note 5) V_{OUT} Increasing V_{OUT} Decreasing | 2.28 2.25 | 2.350 2.300 | $0.98 \times V_{OUT}$ $0.97 \times V_{OUT}$ | V V |
| RESET Threshold for 3.3 V Option HIGH (V _{RH}) LOW (V _{RL}) | 5.5 V \leq V $_{IN}$ \leq 26 V (Note 5) V $_{OUT}$ Increasing V $_{OUT}$ Decreasing | 3.00 2.97 | 3.102 3.036 | $0.98 \times V_{OUT}$ $0.97 \times V_{OUT}$ | V V |
| RESET Threshold for 5.0 V Option HIGH (V _{RH}) LOW (V _{RL}) | V _{OUT} Increasing V _{OUT} Decreasing | 4.55 4.50 | 4.70 4.60 | $0.98 \times V_{OUT}$ $0.97 \times V_{OUT}$ | V V |
| RESET Threshold for 8.0 V Option HIGH (V _{RH}) LOW (V _{RL}) | V _{OUT} Increasing V _{OUT} Decreasing | 7.05 7.00 | 7.52 7.36 | $0.98 \times V_{OUT}$ $0.97 \times V_{OUT}$ | V V |
| RESET Threshold for 10 V Option HIGH (V _{RH}) LOW (V _{RL}) | V _{OUT} Increasing V _{OUT} Decreasing | 8.60 8.50 | 9.40 9.20 | $0.98 \times V_{OUT}$ $0.97 \times V_{OUT}$ | V V |
| Output Voltage Low (V _{RLO}) | $1.0 \text{ V} \leq \text{V}_{OUT} \leq \text{V}_{RL}, \text{R}_{\overline{\text{RESET}}} = 10 \text{ k}$ | _ | 0.1 | 0.4 | V |
| DELAY Switching Threshold (V _{DT}) | _ | 1.4 | 1.8 | 2.2 | V |
| DELAY Low Voltage | V _{OUT} < RESET Threshold Low(min) | _ | _ | 0.1 | V |
| DELAY Charge Current | DELAY = 1.0 V, V _{OUT} > V _{RH} | 1.5 | 2.5 | 3.5 | μA |
| DELAY Discharge Current | DELAY = 1.0 V, V _{OUT} = 1.5 V | 5.0 | - | - | mA |
| Reset Adjust Switching Voltage $(V_{R(ADJ)})$ | _ | 1.23 | 1.31 | 1.39 | V |
| FLAG/Monitor | | | | | |
| Monitor Threshold | Increasing and Decreasing | 1.10 | 1.20 | 1.31 | V |
| Hysteresis | - | 20 | 50 | 100 | mV |
| Input Current | MON = 2.0 V | -0.5 | 0.1 | 0.5 | μA |
| Output Saturation Voltage | MON = 0 V, I _{FLAG} = 1.0 mA | _ | 0.1 | 0.4 | V |
| Voltage Adjust (Adjustable Output | only) | | | | |
| Input Current | V _{ADJ} = 1.28 V | -0.5 | - | 0.5 | μA |

4. Voltage range specified in Output Stage of the Electrical Characteristics in boldface type. 5. For $V_{IN} \le 5.5$ V, a RESET = Low may occur with the output in regulation.

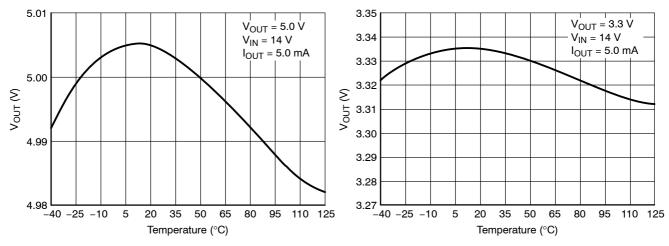
PACKAGE PIN DESCRIPTION, ADJUSTABLE OUTPUT

| Package Pin Number | | | | |
|--------------------|----------------------|------------------|--|--|
| SO-8 | SOW-16 E PAD | Pin Symbol | Function | |
| 1 | 7 | V _{IN} | Input Voltage. | |
| 2 | 8 | MON | Monitor. Input for early warning comparator. If not needed connect to V _{OUT.} | |
| 3, 4 | 3–6, 9–12, 14, 15 | NC | No connection. | |
| 5 | 13 | GND | Ground. All GND leads must be connected to Ground | |
| 6 | 16 | FLAG | Open collector output from early warning comparator. | |
| 7 | 1 | V _{ADJ} | Voltage Adjust. A resistor divider from V _{OUT} to this lead sets the output voltage. | |
| 8 | 2 | V _{OUT} | ±2.0%, 150 mA output. | |

PACKAGE PIN DESCRIPTION, FIXED OUTPUT

| Package | Pin Number | | | |
|---------|------------------------|------------------|---|--|
| SO-8 | SOW-16 E PAD | Pin Symbol | Function | |
| 1 | 7 | V _{IN} | Input Voltage. | |
| 2 | 8 | MON | Monitor. Input for early warning comparator. If not needed connect to VOUT. | |
| 3 | 9 | R _{ADJ} | Reset Adjust. If not needed connect to ground. | |
| 4 | 10 | DELAY | Timing capacitor for RESET function. | |
| 5 | 13 | GND | Ground. All GND leads must be connected to Ground | |
| 6 | 16 | RESET | Active reset (accurate to $V_{OUT} \ge 1.0 \text{ V}$) | |
| 7 | 1 | FLAG | Open collector output from early warning comparator. | |
| 8 | 2 | V _{OUT} | ±2.0%, 150 mA output. | |
| - | 3–6, 11, 12, 14, 15 | NC | No connection. | |

TYPICAL PERFORMANCE CHARACTERISTICS



14

12





V_{IN} = 12 V

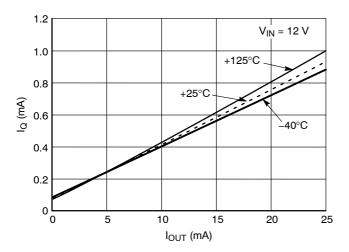


Figure 4. Quiescent Current vs. Output Current

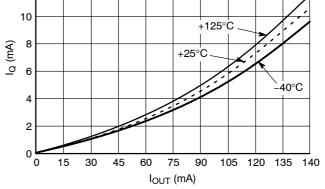
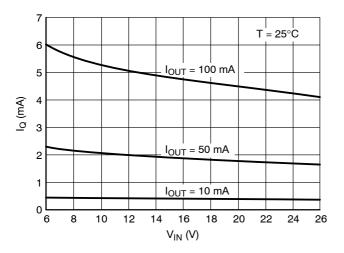
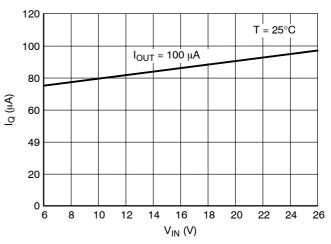


Figure 5. Quiescent Current vs. Output Current









TYPICAL PERFORMANCE CHARACTERISTICS

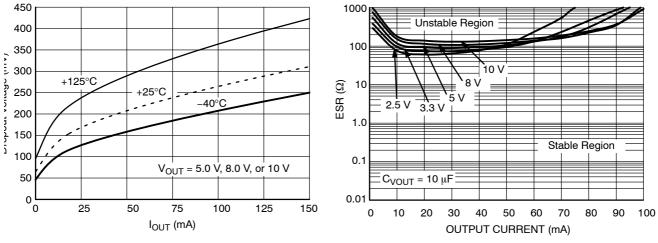
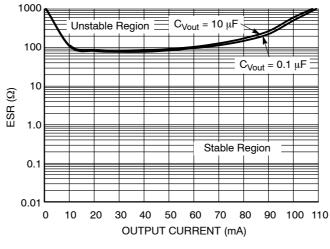


Figure 8. Dropout Voltage vs. Output Current

Figure 9. Output Stability with Output Voltage Change





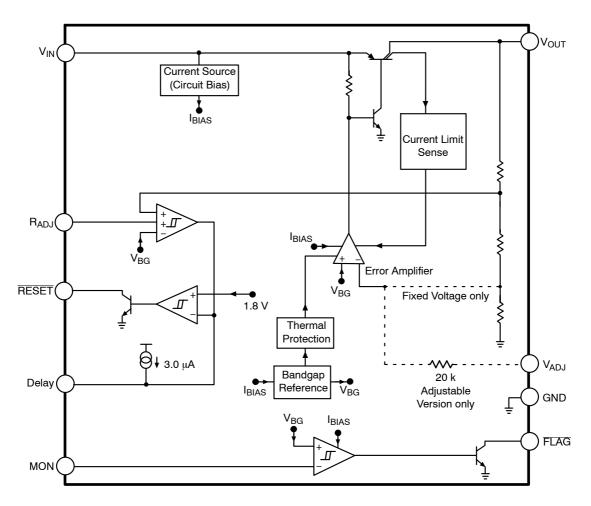
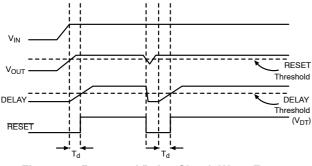


Figure 11. Block Diagram

CIRCUIT DESCRIPTION

REGULATOR CONTROL FUNCTIONS

The NCV8502 contains the microprocessor compatible control function $\overline{\text{RESET}}$ (Figure 12).





RESET Function

A RESET signal (low voltage) is generated as the IC powers up until V_{OUT} is within 6.0% of the regulated output voltage, or when V_{OUT} drops out of regulation, and is lower than 8.0% below the regulated output voltage. Hysteresis is included in the function to minimize oscillations.

The RESET output is an open collector NPN transistor, controlled by a low voltage detection circuit. The circuit is functionally independent of the rest of the IC thereby guaranteeing that the RESET signal is valid for V_{OUT} as low as 1.0 V.

Adjustable Reset Function

The reset threshold can be made lower by connecting an external resistor divider to the R_{ADJ} lead from the V_{OUT} lead, as displayed in Figure 13. This lead is grounded to select the default value of 4.6 V.

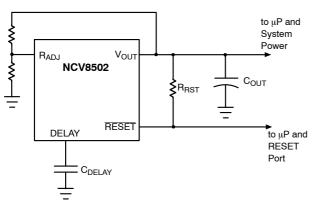


Figure 13. Adjustable RESET

DELAY Function

The reset delay circuit provides a programmable (by external capacitor) delay on the $\overline{\text{RESET}}$ output lead.

The DELAY lead provides source current (typically $2.5 \mu A$) to the external DELAY capacitor during the following proceedings:

- 1. During Power Up (once the regulation threshold has been verified).
- 2. After a reset event has occurred and the device is back in regulation. The DELAY capacitor is discharged when the regulation (RESET threshold) has been violated. This is a latched incident. The capacitor will fully discharge and wait for the device to regulate before going through the delay time event again.

FLAG/Monitor Function

An on-chip comparator is provided to perform an early warning to the microprocessor of a possible reset signal. The reset signal typically turns the microprocessor off instantaneously. This can cause unpredictable results with the microprocessor. The signal received from the FLAG pin will allow the microprocessor time to complete its present task before shutting down. This function is performed by a comparator referenced to the bandgap reference. The actual trip point can be programmed externally using a resistor divider to the input monitor (MON) (Figure 14). The typical threshold is 1.20 V on the MON pin.

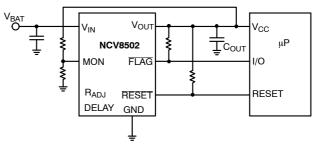


Figure 14. FLAG/Monitor Function

Voltage Adjust

Figure 15 shows the device setup for a user configurable output voltage. The feedback to the V_{ADJ} pin is taken from a voltage divider referenced to the output voltage. The loop is balanced around the Unity Gain threshold (1.28 V typical).

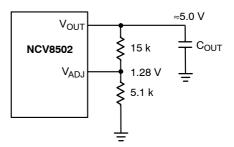


Figure 15. Adjustable Output Voltage

APPLICATION NOTES

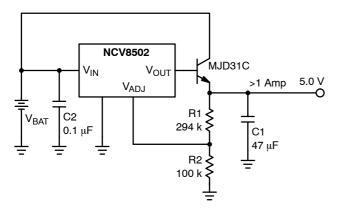


Figure 16. Additional Output Current

Adding Capability

Figure 16 shows how the adjustable version of parts can be used with an external pass transistor for additional current capability. The setup as shown will provide greater than 1 Amp of output current.

FLAG MONITOR

Figure 17 shows the FLAG Monitor waveforms as a result of the circuit depicted in Figure 14. As the output voltage falls (V_{OUT}), the Monitor threshold is crossed. This causes the voltage on the FLAG output to go low sending a warning signal to the microprocessor that a RESET signal may occur in a short period of time. T_{WARNING} is the time the microprocessor has to complete the function it is currently working on and get ready for the RESET shutdown signal.

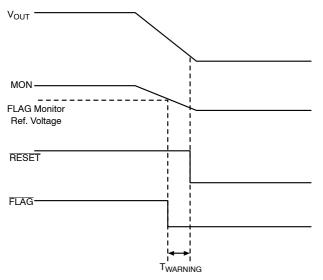
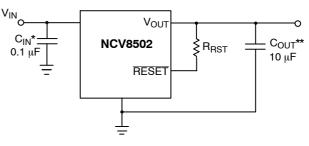


Figure 17. FLAG Monitor Circuit Waveform



*C_{IN} required if regulator is located far from the power supply filter **C_{OUT} required for stability. Capacitor must operate at minimum temperature expected

Figure 18. Test and Application Circuit Showing Output Compensation

SETTING THE DELAY TIME

The delay time is controlled by the Reset Delay Low Voltage, Delay Switching Threshold, and the Delay Charge Current. The delay follows the equation:

$$t_{\text{DELAY}} = \frac{\left[\text{C}_{\text{DELAY}}(V_{\text{dt}} - \text{Reset Delay Low Voltage})\right]}{\text{Delay Charge Current}}$$

Example:

Using $C_{DELAY} = 33$ nF. Assume reset Delay Low Voltage = 0.

Use the typical value for $V_{dt} = 1.8$ V.

Use the typical value for Delay Charge Current = $2.5 \,\mu$ A.

$$DELAY = \frac{\left[33 \text{ nF}(1.8 - 0)\right]}{2.5 \,\mu\text{A}} = 23.8 \text{ ms}$$

STABILITY CONSIDERATIONS

The output or compensation capacitor helps determine three main characteristics of a linear regulator: start–up delay, load transient response and loop stability.

The capacitor value and type should be based on cost, availability, size and temperature constraints.

The value for the output capacitor C_{OUT} shown in Figure 18 should work for most applications, however it is not necessarily the optimized solution.

CALCULATING POWER DISSIPATION IN A SINGLE OUTPUT LINEAR REGULATOR

The maximum power dissipation for a single output regulator (Figure 19) is:

where:

VIN(max) is the maximum input voltage,

V_{OUT(min)} is the minimum output voltage,

 $I_{OUT(max)}$ is the maximum output current for the application, and

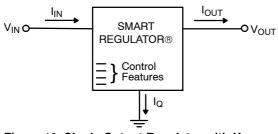
 I_Q is the quiescent current the regulator consumes at $I_{OUT(max)}$.

Once the value of $P_{D(max)}$ is known, the maximum permissible value of R_{0IA} can be calculated:

$$R_{\Theta JA} = \frac{150 \square - T_A}{P_D}$$
 (eq. 2)

The value of $R_{\theta JA}$ can then be compared with those in the package section of the data sheet. Those packages with $R_{\theta JA}$'s less than the calculated value in equation 2 will keep the die temperature below 150°C.

In some cases, none of the packages will be sufficient to dissipate the heat generated by the IC, and an external heatsink will be required.





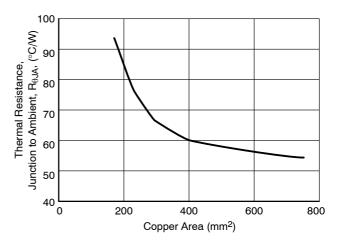


Figure 20. 16 Lead SOW (Exposed Pad), θJA as a Function of the Pad Copper Area (2 oz. Cu Thickness), Board Material = 0.0625" G-10/R-4

HEAT SINKS

A heat sink effectively increases the surface area of the package to improve the flow of heat away from the IC and into the surrounding air.

Each material in the heat flow path between the IC and the outside environment will have a thermal resistance. Like series electrical resistances, these resistances are summed to determine the value of $R_{\theta IA}$:

$$R_{\theta}JA = R_{\theta}JC + R_{\theta}CS + R_{\theta}SA \qquad (eq. 3)$$

where:

 $R_{\theta JC}$ = the junction-to-case thermal resistance,

 $R_{\theta CS}$ = the case-to-heatsink thermal resistance, and

 $R_{\theta SA}$ = the heatsink-to-ambient thermal resistance.

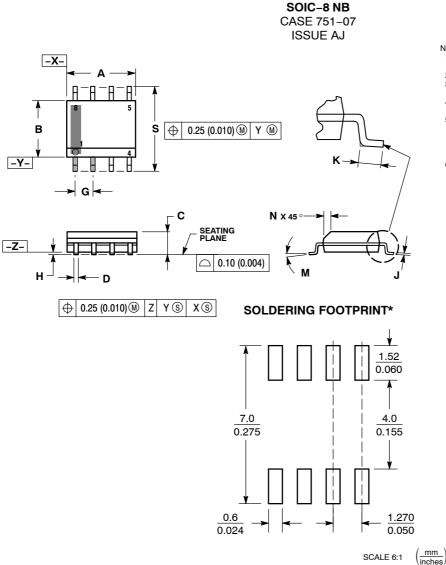
 $R_{\theta JC}$ appears in the package section of the data sheet. Like $R_{\theta JA}$, it too is a function of package type. $R_{\theta CS}$ and $R_{\theta SA}$ are functions of the package type, heatsink and the interface between them. These values appear in heat sink data sheets of heat sink manufacturers.

ORDERING INFORMATION

| Device | Output Voltage | Package | Shipping [†] |
|------------------|----------------|---------------------------------|-----------------------|
| NCV8502DADJG | | SO-8 (Pb-Free) | 98 Units/Rail |
| NCV8502DADJR2G | | SO-8 (Pb-Free) | 2500 Tape & Reel |
| NCV8502PDWADJG | Adjustable | SOW-16 Exposed Pad (Pb-Free) | 47 Units/Rail |
| NCV8502PDWADJR2G | | SOW-16 Exposed Pad (Pb-Free) | 1000 Tape & Reel |
| NCV8502D25G | | SO-8 (Pb-Free) | 98 Units/Rail |
| NCV8502D25R2G | 0.5.1/ | SO-8 (Pb-Free) | 2500 Tape & Reel |
| NCV8502PDW25G | 2.5 V | SOW-16 Exposed Pad (Pb-Free) | 47 Units/Rail |
| NCV8502PDW25R2G | | SOW-16 Exposed Pad (Pb-Free) | 1000 Tape & Reel |
| NCV8502D33G | | SO-8 (Pb-Free) | 98 Units/Rail |
| NCV8502D33R2G | 2.0.1/ | SO-8 (Pb-Free) | 2500 Tape & Reel |
| NCV8502PDW33G | 3.3 V | SOW-16 Exposed Pad (Pb-Free) | 47 Units/Rail |
| NCV8502PDW33R2G | | SOW-16 Exposed Pad (Pb-Free) | 1000 Tape & Reel |
| NCV8502D50G | | SO-8 (Pb-Free) | 98 Units/Rail |
| NCV8502D50R2G | 5.0.1/ | SO-8 (Pb-Free) | 2500 Tape & Reel |
| NCV8502PDW50G | 5.0 V | SOW-16 Exposed Pad (Pb-Free) | 47 Units/Rail |
| NCV8502PDW50R2G | | SOW-16 Exposed Pad (Pb-Free) | 1000 Tape & Reel |
| NCV8502D80G | | SO-8 (Pb-Free) | 98 Units/Rail |
| NCV8502D80R2G | 0.01/ | SO-8 (Pb-Free) | 2500 Tape & Reel |
| NCV8502PDW80G | 8.0 V | SOW-16 Exposed Pad (Pb-Free) | 47 Units/Rail |
| NCV8502PDW80R2G | | SOW-16 Exposed Pad (Pb-Free) | 1000 Tape & Reel |
| NCV8502D100G | | SO-8 (Pb-Free) | 98 Units/Rail |
| NCV8502D100R2G | | SO–8 (Pb–Free) | 2500 Tape & Reel |
| NCV8502PDW100G | 10 V | SOW-16 Exposed Pad (Pb-Free) | 47 Units/Rail |
| NCV8502PDW100R2G | | SOW-16 Exposed Pad (Pb-Free) | 1000 Tape & Reel |

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

PACKAGE DIMENSIONS

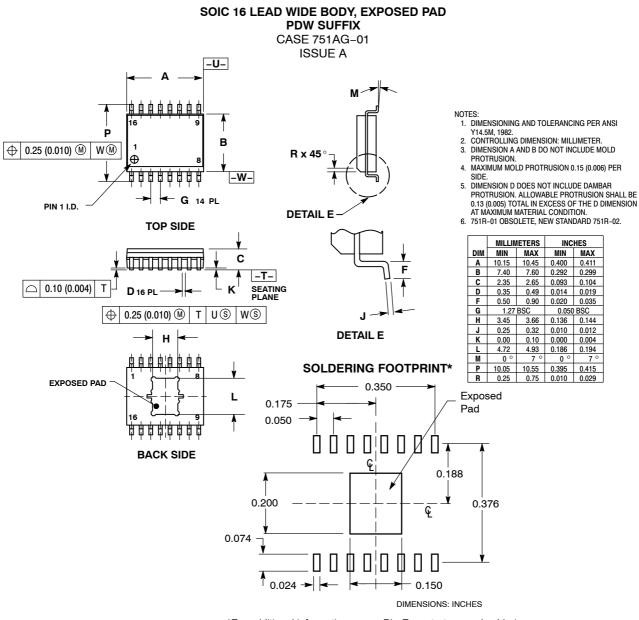


*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

- NOTES:
 DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
 CONTROLLING DIMENSION: MILLIMETER.
 DIMENSION A AND B DO NOT INCLUDE MOLD PROTRUSION.
 MAXIMUM MOLD PROTRUSION 0.15 (0.006) PER SIDE.
 DIMENSION D DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.127 (0.005) TOTAL IN EXCESS OF THE D DIMENSION AT MAXIMUM MATERIAL CONDITION.
 751-01 THRU 751-06 ARE OBSOLETE. NEW STANDARD IS 751-07.

| | MILLIN | IETERS | INCHES | | |
|-----|---------|--------|-----------|-------|--|
| DIM | MIN MAX | | MIN | MAX | |
| Α | 4.80 | 5.00 | 0.189 | 0.197 | |
| в | 3.80 | 4.00 | 0.150 | 0.157 | |
| С | 1.35 | 1.75 | 0.053 | 0.069 | |
| D | 0.33 | 0.51 | 0.013 | 0.020 | |
| G | 1.27 | 7 BSC | 0.050 BSC | | |
| н | 0.10 | 0.25 | 0.004 | 0.010 | |
| J | 0.19 | 0.25 | 0.007 | 0.010 | |
| к | 0.40 | 1.27 | 0.016 | 0.050 | |
| М | 0° 8° | | 0 ° | 8 ° | |
| Ν | 0.25 | 0.50 | 0.010 | 0.020 | |
| S | 5.80 | 6.20 | 0.228 | 0.244 | |

PACKAGE DIMENSIONS



*For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

SMART REGULATOR is a registered trademark of Semiconductor Components Industries, LLC.

ON Semiconductor and use registered trademarks of Semiconductor Components Industries, LLC (SCILLC). SCILLC reserves the right to make changes without further notice to any products herein. SCILLC makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does SCILLC assume any liability arising out of the application or use of any provided in SCILLC data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. SCILLC does not convey any license under its patent rights nor the rights of others. SCILLC products are not designed, intended, or authorized for use as components in systems intended for surgical implant into the body, or other applications intended to support or sustain life, or for any other application in which the failure of the SCILLC product create a situation where personal injury or death may occur. Should Buyer purchase or use SCILLC products for any such unintended or unauthorized application, Buyer shall indemnify and hold SCILLC and its officers, employees, subsidiaries, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use persons, and reasonable attorney fees and is on manufacture of the part. SCILLC is an Equal Opportunity/Affirmative Action Employer. This literature is subject to all applicable copyright laws and is not for resale in any manner.

PUBLICATION ORDERING INFORMATION

LITERATURE FULFILLMENT:

Literature Distribution Center for ON Semiconductor P.O. Box 5163, Denver, Colorado 80217 USA Phone: 303–675–2175 or 800–344–3860 Toll Free USA/Canada Fax: 303–675–2176 or 800–344–3867 Toll Free USA/Canada Email: orderlit@onsemi.com N. American Technical Support: 800–282–9855 Toll Free USA/Canada Europe, Middle East and Africa Technical Support:

Europe, Middle East and Africa Technical Support: Phone: 421 33 790 2910 Japan Customer Focus Center Phone: 81-3-5773-3850

ON Semiconductor Website: www.onsemi.com

Order Literature: http://www.onsemi.com/orderlit

For additional information, please contact your local Sales Representative

X-ON Electronics

Largest Supplier of Electrical and Electronic Components

Click to view similar products for LDO Voltage Regulators category:

Click to view products by ON Semiconductor manufacturer:

Other Similar products are found below :

M38D29FFHP#U1 702103A 717726C 742457H MP20051DN-LF-Z R5F111PGGFB#30 AP7363-SP-13 NCP103AMX285TCG NCV8664CST33T3G NCV8752AMX28TCG L9454 AP7362-HA-7 LX13043CLD TCR3DF185,LM(CT TCR3DF24,LM(CT TCR3DF285,LM(CT TCR3DF31,LM(CT TCR3DF45,LM(CT TLF4949EJ MP2013GQ-33-Z L9708 L970813TR 030014BB 059985X NCP121AMX173TCG NCP4687DH15T1G NCV8703MX30TCG 701326R 702087BB 755078E TCR2EN28,LF(S LM1117DT-1.8/NO LT1086CM#TRPBF AZ1085S2-1.5TRE1 MAX15101EWL+T NCV8170AXV250T2G SCD337BTG TCR3DF27,LM(CT TCR3DF19,LM(CT TCR3DF125,LM(CT MAX15103EWL+T TS2937CZ-5.0 C0 MAX8878EUK30-T MAX663CPA NCV4269CPD50R2G NCV8716MT30TBG AZ1117IH-1.2TRG1 MP2013GQ-P AP2112R5A-3.3TRG1 AP7315-25W5-7